



Open Access at IEEE

Workflow for Authors

Navigating the open access publication process from submission to acceptance to OA funding



Author Process

Submission, acceptance and funding

Submission – Step 1

<https://publication-recommender.ieee.org/home>

IEEE Publication Recommender helps authors find the most suitable journal and displays journal's OA Status with submission URL

Note: Open Access status clearly displayed in results.

The screenshot displays the IEEE Publication Recommender interface. On the left, there are search options: 'Both Periodicals and Conferences', 'Periodicals only', and 'Conferences only'. A search box contains 'Electron Devices', and a dropdown menu shows results under 'PERIODICALS' and 'CONFERENCES'. The 'PERIODICALS' results include 'Electron Devices, IEEE Transactions on', 'Electron Devices Society, IEEE Journal of the', and 'Electron Device Letters, IEEE'. The 'CONFERENCES' results include '2020 IEEE International Electron Devices Meeting (IEDM)', '2021 IEEE International Electron Devices Meeting (IEDM)', '2023 International Electron Devices Meeting (IEDM)', '2022 International Electron Devices Meeting (IEDM)', and '2024 IEEE International Electron Devices Meeting'. On the right, a detailed view for 'Periodical: Electron Devices Society, IEEE Journal of the' is shown. It includes a table of metrics: Impact Factor (2), Eigenfactor (0.00259), and Article Influence Score (0.764). Below this is a table for 'Open Access Availability' showing 'Open Access Only' status, 'Submission to Publication in Xplore' as 'Not yet available', and 'Issues per year' as '1'. The 'Aims & Scope' section describes the journal as an open-access, fully electronic scientific journal. The 'Published By' and 'Contact' information is also listed as 'Not yet available'. An orange arrow points from the note above to the 'Open Access Availability' table.

IEEE Publication Recommender™
Find the best match for your scholarly article

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- Download the results of your search

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- Both Periodicals and Conferences
- Periodicals only
- Conferences only

Narrow by date: (Optional)

Or, find details for a specific publication

Enter the name of a periodical or conference

PERIODICALS

- Electron Devices, IEEE Transactions on
- Electron Devices Society, IEEE Journal of the
- Electron Device Letters, IEEE

CONFERENCES

- 2020 IEEE International Electron Devices Meeting (IEDM)
- 2021 IEEE International Electron Devices Meeting (IEDM)
- 2023 International Electron Devices Meeting (IEDM)
- 2022 International Electron Devices Meeting (IEDM)
- 2024 IEEE International Electron Devices Meeting

IEEE Publication Recommender™
Find the best match for your scholarly article

Periodical: Electron Devices Society, IEEE Journal of the

Impact Factor:	2
Eigenfactor:	0.00259
Article Influence Score:	0.764

Open Access Availability:	Open Access Only
Submission to Publication in Xplore:	Not yet available
Issues per year:	1

Aims & Scope:

The IEEE Journal of the Electron Devices Society (J-EDS) is an open-access, fully electronic scientific journal publishing papers ranging from fundamental to applied research that are scientifically rigorous and relevant to electron devices. The J-EDS publishes original and significant contributions relating to the theory, modelling, design, performance, and reliability of electron and ion integrated circuit devices and

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Submission – Step 1 – in IEEE Xplore

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Show active titles only 

IEEE Access

Publisher: IEEE Years: 2013 - Present Most Recent Issue

IEEE Aerospace and Electronic Systems Magazine

Publisher: IEEE Years: 1986 - Present Most Recent Issue

IEEE Transactions on Aerospace and Electronic Systems

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IEEE Open Journal of Antennas and Propagation

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The IEEE Open Journal of Antennas and Propagation covers antennas, including analysis, design, development, measurement, standards, and testing; radiation, propagation, and the interaction of electromagnetic waves with discrete and continuous media; and applications and systems pertinent to antennas, propagation, and sensing, such as applied optics, millimeter-and sub-millimeter-wave techniques, antenna signal processing and control, radio astronomy, and propagation and radiation aspects of terrestrial and space-based communication, including wireless, mobile, satellite, and telecommunications at all frequencies.

The IEEE Open Journal of Antennas and Propagation (IEEE OJAP) welcomes contributions covering aspects from theory and design to applied engineering innovations, topical review, and perspective articles. The journal publishes papers on mature topics as well as on emerging fields, including those at the nexus of other engineering and science disciplines that are dependent upon antennas and propagation. IEEE OJAP is committed to supporting open and transparent research exchange and enabling authors to embrace best practices in data and code sharing.

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Submission process

- The corresponding author will complete the submission process.
 - Authors submitting to **fully OA journals** will be asked to accept OA terms and charges during Step 1.
 - Authors submitting to **hybrid journals** will not be asked to select OA until after acceptance.

Submission – Step 1 – Fully OA journal

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Submission

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- Step 1: Type, Title, & Abstract >
- Step 2: Attributes >
- Step 3: Authors & Institutions >
- Step 4: Reviewers >
- Step 5: Details & Comments >
- Step 6: File Upload >
- Step 7: Review & Submit >

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Submission process – Step 2

General requirements may vary journal to journal, but there are several key elements that are important to complete at this time to ensure proper Open Access processing later during publication

- Assigning Authors
- Identifying Institution

Adding Authors During Submission

The corresponding author enters all co-author information.

If the co-author does not have an account, the corresponding author will create one, and add institution data.

The corresponding author's institution data will be used to match the author with their institutional OA account.

Note: Some institutions will not fund publication if their institution is not listed first.

Submission

- Step 1: Type, Title, & Abstract >
- Step 2: File Upload >
- Step 3: Attributes >
- Step 4: Authors & Institutions >**
- Step 5: Reviewers & Editors >
- Step 6: Details & Comments >
- Step 7: Review & Submit >

Enter your co-authors' information in the boxes below, then click "Add to My Authors." To check if an author already exists in the journal's database, enter the author's e-mail address and click "Find." If the author is found, their information will be automatically filled out for you. When you are finished, click "Save and Continue."

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Post acceptance – hybrid review

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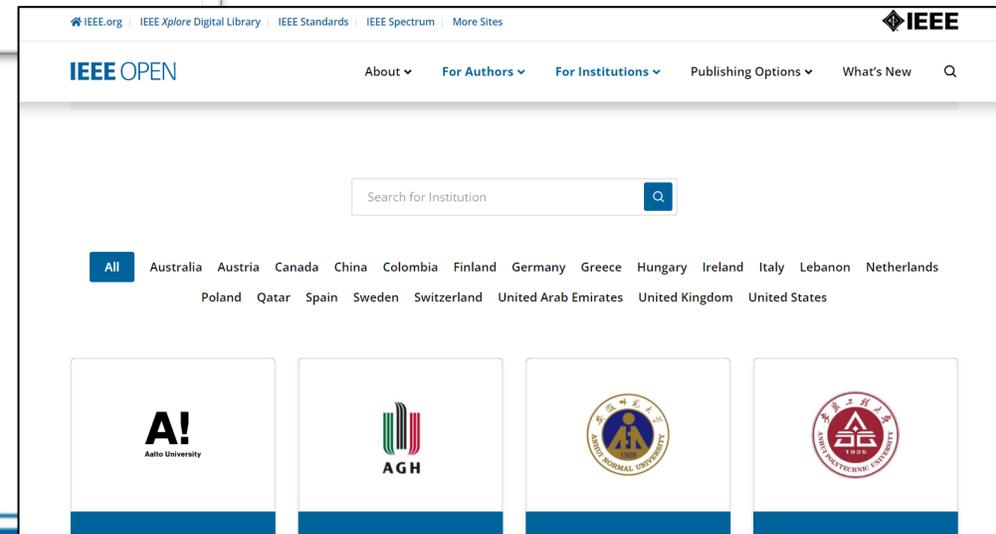
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- Yes** - please make my article Open Access. I understand that there is a \$2,195 APC associated with Open Access publication. Some institutions offer assistance for open access funding. Check our [institutional partners list](#) to see if yours is one.
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IEEE supports author choice when publishing in a hybrid journal.

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The screenshot shows the IEEE Open Access website. At the top, there is a navigation bar with links for IEEE.org, IEEE Xplore Digital Library, IEEE Standards, IEEE Spectrum, and More Sites. Below this is the "IEEE OPEN" logo and a search bar labeled "Search for Institution". A list of countries is displayed, including Australia, Austria, Canada, China, Colombia, Finland, Germany, Greece, Hungary, Ireland, Italy, Lebanon, Netherlands, Poland, Qatar, Spain, Sweden, Switzerland, United Arab Emirates, United Kingdom, and United States. Below the list, four institutional logos are shown: Aalto University, AGH, and two others.

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Post acceptance – hybrid journal

Authors who choose “traditional submission” in a hybrid title will receive an email informing them of the opportunity to publish OA if an active OA agreement is present based on the corresponding author’s affiliation.

Note: The email is sent only if the profile associated with the article is set a “Touch free” in RLSC.

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10.1109/JPHOTOV.2021.3086455

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